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Microsemi

Power and Microelectronics Group (PMG) – Phoenix Division

Product Change Notification

Date: Friday, September 24, 2010

PCN#: 140A00190

Subject: Package 400 - 66 Pin, PGA Type, Ceramic Hex-in-Line Package, HIP (H1) Drawing Change

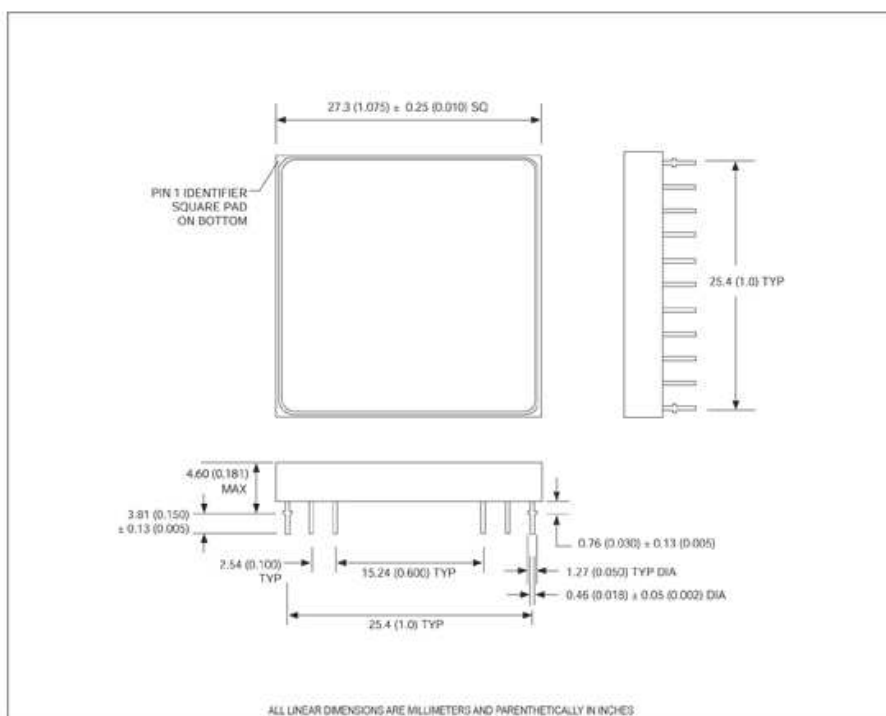
Dear Customer,

In an effort to better communicate to you, our user community, we have implemented a e-mail version for our PCN process in addition to our PCN website. While you may receive a notification from us concerning a particular part or part numbers, it is not an indication that you use or have ordered these particular parts, but merely a communication to notify our user community as a whole. Please review your sales orders, POs, records, etc. to determine if this particular PCN impacts your activities or affects your business.

Microsemi Power and Microelectronics Group wishes to inform you of a Mechanical Outline drawing change to the 66 Pin, PGA Type, Ceramic Hex-in-Line package, HIP (H1). A second source for this package is available so the drawing will be generic to both packages. The following part numbers will be affected:

WS128K32-XXX	5962-93187XXXXX	5962-96900XXXXX
WE32K32-XXX	5962-94716XXXXX	C50371
WE128K32-XXX	5962-94585XXXXX	C50422
WF128K32-XXX	5962-94612XXXXX	C50447
WF512K32-XXX	5962-94614XXXXX	C50475
WSF128K16-XXX	5962-95565XXXXX	C50592

PACKAGE 400: 66 PIN, PGA TYPE, CERAMIC HEX-IN-LINE PACKAGE, HIP (H1)



If you have any questions, please contact the factory.

As technology moves at a much faster pace, advanced embedded electronic components play a more strategic role. Constant changes and advancements in technology mandate that we anticipate changes and directions in technology for the benefit of our customers. As one of the pioneers in advanced semiconductor packaging and high-density memory solutions, we stand ready to assist you in managing this evolution of technology. If we can provide any additional assistance, please contact us at 602.437.1520 or complete a contact form at www.whiteedc.com/contact_us.html.

Best regards,
Microsemi Power and Microelectronics Group Engineering

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